consemi  Contact Name  Title - Contact  Phone - Contact*  Email - Contact*  Product-Env-Stewards  Authorized Representative*  Product Enviro Compliance  NA  Product-Env-Stewards@onsemi.compliance  Phone - Representative*  Email - Representative*	© Co	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
Company name* Company unique ID  Unique ID Authority  Response Date*  2023-06-08  Contact Name  Title - Contact  Product Enviro Compliance  NA  Product Enviro Compliance  Unique ID Authority  Phone - Contact*  Phone - Contact*  Product-Env-Stewards  Unique ID Authority  Phone - Contact*  Phone - Contact*  Product-Env-Stewards  One - Representative*  Product-Env-Stewards  Product-Env-Stewards  Product-Env-Stewards  Product-Env-Stewards  One - Representative*  Product-Env-Stewards  One - Representative*  Product-Env-Stewards  One - Representative*  Product-Env-Stewards  One - Representative*  Product-Env-Stewards  One - Representative  Product-Env-Stewards  One - Representative  Product-Env-Stewards  One - Representative  Version  Manufacturing Site  Weight*  UOM  Vanufacturing Proccess Information  Vanufacturing Proccess Information  Vanufacturing Proccess Information  Terminal Plating / Grid Array Material											nd Mfg Informati	on			
Insemi In	nformation	n													
Title - Contact Name Product Env-Stewards Uthorized Representative* Product Env-Stewards Product Enviro Compliance Product Env-Stewards Product Enviro Compliance Phone - Representative* Product Env-Stewards Product Enviro Compliance NA Product Env-Stewards Product Env-Stewards Product Enviro Compliance NA Product Env-Stewards @onsemi.c  Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight* UOM  Anufacturing Proccess Information  Terminal Plating / Grid Array Material Terminal Base Alloy NA Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cy Matte Tin (Sn) - annealed CU Alloy NA 0 C 30 seconds 3  ■ Number of Reflow Cy	Company name*			Company unique ID			1	Unique ID Authority				Response Date*			
Product-Env-Stewards uthorized Representative* Title - Representative Product-Env-Stewards Pr	onsemi											2023-06-08			
tuthorized Representative*  Product Enviro Compliance  Requester Item Number  Mfr Item Number  Mfr Item Name  Effective Date  Version  Manufacturing Site  Weight*  UOM  NCV78L05ABPG  ANA POS VREG 5V 100MA  Deal Product Enviro Compliance  Terminal Plating / Grid Array Material  Terminal Base Alloy  Matte Tin (Sn) - annealed  CU Alloy  NA  Phone - Representative*  NA  Product-Env-Stewards © onsemi.ce  Weight*  UOM  Deal Peak Process Body Temperature  Max Time at Peak Temperature  Number of Reflow Cy  Na  O  C  30  Seconds  3	Contact Name				Title - Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards  Requester Item Number  Mfr Item Number  Mfr Item Name  Effective Date  Version  Manufacturing Site  Weight*  UOM  NCV78L05ABPG  ANA POS VREG 5V 100MA  2023-06-08  CNF  198.01  mg  Manufacturing Process Information  Terminal Plating / Grid Array Material  Terminal Base Alloy  Matte Tin (Sn) - annealed  CU Alloy  NA  Product-Env-Stewards@onsemi.co  Weight*  UOM  Product-Env-Stewards@onsemi.co  Weight*  UOM  Product-Env-Stewards@onsemi.co  Weight*  UOM  Product-Env-Stewards@onsemi.co  Weight*  UOM  Page Process Information  O  CNF  Max Time at Peak Temperature  Number of Reflow Cy  Na  O  C  30  Seconds  3	Product-Env-Stewards			Product Enviro Compliance				NA			Pro	Product-Env-Stewards@onsemi.com			
Requester Item Number	Authorized Representative*			Title - Representative			]	Phone - Representative*			Ema	Email - Representative*			
NCV78L05ABPG ANA POS VREG 5V 100MA 2023-06-08 CNF 198.01 mg    Internation   Internati	Product-Env-Stewards Product Enviro Compli			iro Compliance	bliance NA			P			Product-Env-Stewards@onsemi.com				
Terminal Plating / Grid Array Material   Terminal Base Alloy   J-STD-020 MSL Rating   Peak Process Body Temperature   Max Time at Peak Temperature   Number of Reflow Cy	Requester Item I	n Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	Manufacturing	Manufacturing Site		UOM	Unit Type	
Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cy Matte Tin (Sn) - annealed CU Alloy NA 0 C 30 seconds 3		NCV78L05ABPG ANA POS V		ANA POS VREG	REG 5V 100MA		2023-06-08		CNF		198.01	mg	Each		
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Patter III (bi) dimensed Co IIIo) 1112   0   C   D0   Secondo D	8 - m s, m						SL Rating						er of Reflow Cy	cles	
omments	latte Tin (Sn) -	) - annealed	C	U Alloy		NA			IC IC	30	S	econds 5			
or more information regarding material composition please refer to page 3		**	•.•	1 0 .											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct at it in member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of					
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per t	he definition above except for defined Rol	IS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.2	mg	Supplier	Silicon (Si)	7440-21-3		3.2	mg
Die Attach	5.15	mg	Supplier	Silver (Ag)	7440-22-4		4.3775	mg
			Supplier	Phenolic Resin	Proprietary Data		0.7725	mg
Lead Frame	80.67	mg	Supplier	Silver (Ag)	7440-22-4		0.0081	mg
			Supplier	Iron (Fe)	7439-89-6		0.0807	mg
			Supplier	Copper (Cu)	7440-50-8		80.5571	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0242	mg
Mold Compound-Black	106.15	mg		Phenol Resin	proprietary data		10.615	mg
			Supplier	Carbon Black (C)	1333-86-4		1.0615	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		81.7355	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		12.738	mg
Plating	2.74	mg	Supplier	Tin (Sn)	7440-31-5		2.74	mg
Wire Bond - Au	0.1	mg	Supplier	Gold (Au)	7440-57-5		0.1	mg